January 15, 2012

M78LXX Series 3-Terminal Positive Regulators



LM78LXX Series

3-Terminal Positive Regulators

General Description

The LM78LXX series of three terminal positive regulators is available with several fixed output voltages making them useful in a wide range of applications. When used as a zener diode/resistor combination replacement, the LM78LXX usually results in an effective output impedance improvement of two orders of magnitude, and lower quiescent current. These regulators can provide local on card regulation, eliminating the distribution problems associated with single point regulation. The voltages available allow the LM78LXX to be used in logic systems, instrumentation, HiFi, and other solid state electronic equipment.

The LM78LXX is available in the plastic TO-92 (Z) package, the plastic SO-8 (M) package and a chip sized package (8-Bump micro SMD) using National's micro SMD package technology. With adequate heat sinking the regulator can deliver 100mA output current. Current limiting is included to limit the peak output current to a safe value. Safe area protection for the output transistors is provided to limit internal power dissi-

Connection Diagrams





pation. If internal power dissipation becomes too high for the heat sinking provided, the thermal shutdown circuit takes over preventing the IC from overheating.

Features

- LM78L05 in micro SMD package
- Output voltage tolerances of ±5% over the temperature range
- Output current of 100mA
- Internal thermal overload protection
- Output transistor safe area protection
- Internal short circuit current limit
- Available in plastic TO-92 and plastic SO-8 low profile packages
- No external components
- Output voltages of 5.0V, 6.2V, 8.2V, 9.0V, 12V, 15V
- See AN-1112 for micro SMD considerations



LM78LXX Series

Ordering Information

Package Type	NSC Drawing	Output Voltage	Operating Temperature Range	Order Number	Supplied As
micro SMD	BPA08AAB	5.0V	–40°C to 85°C	LM78L05IBP	OBSOLETE
micro Sivid	BPAUSAAB	5.00	-40°C 10 85°C	LM78L05IBPX	OBSOLETE
		5.0V	–40°C to 85°C	LM78L05ITP	Reel of 250
Thin micro SMD	TPA08AAA	5.00	-40 C 10 65 C	LM78L05ITPX	Reel of 3000
		9.0V	-40°C to 85°C	LM78L09ITP	OBSOLETE
		9.00	-40 C 10 85 C	LM78L09ITPX	Reel of 3000
			0°C to 125°C	LM78L05ACM	Rail of 95
	M08A -	5.0V	0 0 10 120 0	LM78L05ACMX	Reel of 2500
			-40°C to 125°C	LM78L05AIM	Rail of 95
SOIC Narrow				LM78L05AIMX	Reel of 2500
SOIC Nation	MOOA		0°C to 125°C	LM78L12ACM	Rail of 95
		120	0 0 10 125 0	LM78L12ACMX	Reel of 2500
		15V	0°C to 125°C	LM78L15ACM	Rail of 95
		130	0 0 10 125 0	LM78L15ACMX	Reel of 2500
		5.0V	0°C to 125°C	LM78L05ACZ	Box of 1800
		6.2V	0°C to 125°C	LM78L62ACZ	Box of 1800
TO-92	Z03A	8.2V	0°C to 125°C	LM78L82ACZ	OBSOLETE
10-92	2004	9.0V	0°C to 125°C	LM78L09ACZ	OBSOLETE
		12V	0°C to 125°C	LM78L12ACZ	Box of 1800
	Γ	15V	0°C to 125°C	LM78L15ACZ	Box of 1800

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/ Distributors for availability and specifications.

Power Dissipation (<i>Note 5</i>)	Internally Limited
Input Voltage	35V
Storage Temperature	-65°C to +150°C
ESD Susceptibility (Note 2)	1kV

Operating Junction Temperature	
LM78LxxACZ, TO-92	0°C to 125°C
LM78LxxACM, SO-8	0°C to 125°C
LM78LxxAIM, SO-8	-40°C to 125°C
LM78LxxIBPX, micro SMD	-40°C to 85°C
LM78LxxITP, Thin micro SMD	-40°C to 85°C
Soldering Information	
Infrared or Convection (20 sec.)	235°C
Wave Soldering (10 sec.)	260°C (lead time)

LM78LXX Electrical Characteristics Limits in standard typeface are for $T_J = 25^{\circ}$ C, **Bold typeface applies over the entire operating temperature range of the indicated package.** Limits are guaranteed by production testing or correlation techniques using standard Statistical Quality Control (SQC) methods. Unless otherwise specified: $I_0 = 40$ mA, $C_1 = 0.33\mu$ F, $C_0 = 0.1\mu$ F.

LM78L05AC / LM78L05I

Unless otherwise specified, $V_{IN} = 10V$

Symbol	Parameter	Conditions	Min	Тур	Max	Units
Vo	Output Voltage		4.8	5	5.2	
	$7V \le V_{IN} \le 20V$	$7V \le V_{IN} \le 20V$				
		1mA ≤ I _O ≤ 40mA	4.75		5.25	v
		(<i>Note 3</i>)				v
		1mA ≤ I _O ≤ 70mA	4.75		5.25	
		(<i>Note 3</i>)	4.75		0.20	
ΔV _O	Line Regulation	$7V \le V_{IN} \le 20V$		18	75	
		$8V \le V_{IN} \le 20V$		10	54	
ΔV _O	Load Regulation	$1 \text{mA} \le \text{I}_{O} \le 100 \text{mA}$		20	60	mV
		$1 \text{mA} \le \text{I}_{O} \le 40 \text{mA}$		5	30	1
l _Q	Quiescent Current			3	5	
ΔI _Q	Quiescent Current Change	$8V \le V_{IN} \le 20V$			1.0	mA
		1mA ≤ I _O ≤ 40mA			0.1	
V _n	Output Noise Voltage	f = 10 Hz to 100 kHz (<i>Note</i>		40		μV
		4)				μv
ΔV_{IN}	Ripple Rejection	f = 120 Hz	47	62		dB
ΔV _{OUT}		$8V \le V_{IN} \le 16V$	77	02		ЧD
I _{PK}	Peak Output Current			140		mA
$\frac{\Delta V_O}{\Delta T}$	Average Output Voltage Tempco	I _O = 5mA		-0.65		mV/°C
ΔΤ				-0.05		1110/ 0
V _{IN} (Min)	Minimum Value of Input Voltage			6.7	7	v
	Required to Maintain Line Regulation			0.7	<u> </u>	v
θ _{JA}	Thermal Resistance			230.9		°C/W
	(8-Bump micro SMD)					

LM78L62AC

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Symbol	Parameter	Conditions	Min	Тур	Max	Units
Vo	Output Voltage		5.95 6.2	6.2	6.45	
		$8.5V \le V_{IN} \le 20V$	5.0			
		1mA ≤ I _O ≤ 40mA (<i>Note 3</i>)	5.9		6.5	V
		1mA ≤ I _O ≤ 70mA (<i>Note 3</i>)	5.9		6.5	
ΔV _O	Line Regulation	$8.5V \le V_{IN} \le 20V$		65 175	175	
		$9V \le V_{IN} \le 20V$		55	125	
ΔV _O	Load Regulation	1mA ≤ I _O ≤ 100mA		13	80	mV
		1mA ≤ I _O ≤ 40mA		6	6 40	
l _Q	Quiescent Current			2	5.5	
ΔI _Q	Quiescent Current Change	$8V \le V_{IN} \le 20V$			1.5	mA
		$1 \text{mA} \le \text{I}_{O} \le 40 \text{mA}$			0.1	
V _n	Output Noise Voltage	f = 10 Hz to 100 kHz (<i>Note 4</i>)		50		μV
$\frac{\Delta V_{\text{IN}}}{\Delta V_{\text{OUT}}}$	Ripple Rejection	$f = 120 \text{ Hz}$ $10 \text{V} \le \text{V}_{\text{IN}} \le 20 \text{V}$	40	46		dB
I _{PK}	Peak Output Current			140		mA
<u>ΔV_O</u> ΔT	Average Output Voltage Tempco	I _O = 5mA		-0.75		mV/°C
V _{IN} (Min)	Minimum Value of Input Voltage Required to Maintain Line Regulation			7.9		v

LM78L82AC

Unless otherwise specified, $V_{IN} = 14V$

Symbol	Parameter	Conditions	Min	Тур	Max	Units
V _o	Output Voltage		7.87	8.2	8.53	
		$11V \le V_{IN} \le 23V$				
		$1mA \le I_O \le 40mA$	7.8		8.6	v
		(Note 3)				v
		1mA ≤ I _O ≤ 70mA	7.8		8.6	
		(Note 3)				
ΔV _O	Line Regulation	$11V \le V_{IN} \le 23V$		80	175	
		$12V \le V_{IN} \le 23V$		70	125	mV
ΔV _O	Load Regulation	1mA ≤ I _O ≤ 100mA		15	80	mv
		1mA ≤ I _O ≤ 40mA		8	40	1
l _Q	Quiescent Current			2	5.5	
ΔI _Q	Quiescent Current Change	$12V \le V_{IN} \le 23V$			1.5	mA
		$1 \text{mA} \le \text{I}_{\text{O}} \le 40 \text{mA}$			0.1	
V _n	Output Noise Voltage	f = 10 Hz to 100 kHz		60		μV
		(<i>Note 4</i>)		00		μV
ΔV_{IN}	Ripple Rejection	f = 120 Hz	39	45		dB
ΔV _{OUT}		$12V \le V_{IN} \le 22V$		40		ub
I _{PK}	Peak Output Current			140		mA

Symbol	Parameter	Conditions	Min	Тур	Max	Units
$\frac{\Delta V_O}{\Delta T}$	Average Output Voltage Tempco	I _O = 5mA		-0.8		mV/°C
V _{IN} (Min)	Minimum Value of Input Voltage Required to Maintain Line Regulation			9.9		v

LM78L09AC / LM78L09I

Unless otherwise specified, $V_{IN} = 15V$

Symbol	Parameter	Conditions	Min	Тур	Max	Units
Vo	Output Voltage		8.64	9.0	9.36	
		$11.5V \le V_{IN} \le 24V$ $1mA \le I_O \le 40mA$ (<i>Note 3</i>)	8.55		9.45	v
		1mA ≤ I _O ≤ 70mA (<i>Note 3</i>)	8.55		9.45	
ΔV _O	Line Regulation	$11.5V \le V_{IN} \le 24V$		100	200	
		$13V \le V_{IN} \le 24V$		90	150	
ΔV _O	Load Regulation	1mA ≤ I _O ≤ 100mA		20	90	mV
		$1mA \le I_O \le 40mA$		10	45	
IQ	Quiescent Current	-		2	5.5	
ΔI _Q	Quiescent Current Change	$11.5V \le V_{IN} \le 24V$			1.5	mA
		1mA ≤ I _O ≤ 40mA			0.1	
V _n	Output Noise Voltage			70		μV
$\frac{\Delta V_{IN}}{\Delta V_{OUT}}$	Ripple Rejection	$f = 120 \text{ Hz}$ $15 \text{V} \le \text{V}_{\text{IN}} \le 25 \text{V}$	38	44		dB
I _{PK}	Peak Output Current			140		mA
<u>ΔV_O</u> ΔT	Average Output Voltage Tempco	I _O = 5mA		-0.9		mV/°C
V _{IN} (Min)	Minimum Value of Input Voltage Required to Maintain Line Regulation			10.7		v

LM78L12AC

Unless otherwise specified, $V_{IN} = 19V$

Symbol	Parameter	Conditions	Min	Тур	Max	Units
Vo	Output Voltage		11.5	12	12.5	
	$14.5V \le V_{IN} \le 27V$ $1mA \le I_O \le 40mA$ (<i>Note 3</i>) $1mA \le I_O \le 70mA$ (<i>Note 3</i>)	11.4		12.6	v	
		Ũ	11.4		12.6	
ΔV _O	Line Regulation	$14.5V \le V_{IN} \le 27V$		30	180	
		$16V \le V_{IN} \le 27V$		20	110	mV
ΔV _O	Load Regulation	1mA ≤ I _O ≤ 100mA		30	100	mv
		$1 \text{mA} \le \text{I}_{\text{O}} \le 40 \text{mA}$		10	50	
Ι _Q	Quiescent Current			3	5	
ΔI _Q	Quiescent Current Change	$16V \le V_{IN} \le 27V$			1	mA
		$1 \text{mA} \le \text{I}_{O} \le 40 \text{mA}$			0.1	
V _n	Output Noise Voltage			80		μV

LM78LXX Series

LM78LXX Series

Symbol	Parameter	Conditions	Min	Тур	Max	Units
$\frac{\Delta V_{IN}}{\Delta V_{OUT}}$	Ripple Rejection	f = 120 Hz 15V ≤ V _{IN} ≤ 25	40	54		dB
РК	Peak Output Current			140		mA
$\frac{\Delta V_O}{\Delta T}$	Average Output Voltage Tempco	I _O = 5mA		-1.0		mV/°C
V _{IN} (Min)	Minimum Value of Input Voltage Required to Maintain Line Regulation			13.7	14.5	v

LM78L15AC

Unless otherwise specified, $V_{IN} = 23V$

Symbol	Parameter	Conditions	Min	Тур	Мах	Units
Vo	Output Voltage		14.4	15.0	15.6	
		$17.5V \le V_{IN} \le 30V$				
		1mA ≤ I _O ≤ 40mA	14.25		15.75	v
		(<i>Note 3</i>)				ľ
		1mA ≤ I _O ≤ 70mA	14.25		15.75	
		(Note 3)	14.25		10.70	
ΔV _O	Line Regulation	$17.5V \le V_{IN} \le 30V$		37	250	
		$20V \le V_{IN} \le 30V$		25	140	
۷۷ ⁰	Load Regulation	1mA ≤ I _O ≤ 100mA		35	150	mV
		1mA ≤ I _O ≤ 40mA		12	75	
Ι _Q	Quiescent Current			3	5	
ΔI _Q	Quiescent Current Change	$20V \le V_{IN} \le 30V$			1	mA
		1mA ≤ I _O ≤ 40mA			0.1	
V _n	Output Noise Voltage			90		μV
ΔV_{IN}	Ripple Rejection	f = 120 Hz	37	51		٩D
ΔV _{OUT}		$18.5 \mathrm{V} \leq \mathrm{V_{IN}} \leq 28.5 \mathrm{V}$	37	51		dB
I _{PK}	Peak Output Current			140		mA
$\frac{\Delta V_O}{\Delta T}$	Average Output Voltage Tempco	I _O = 5mA		-1.3		mV/°C
V _{IN} (Min)	Minimum Value of Input Voltage			16.7	17.5	v
	Required to Maintain Line Regulation					

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Electrical specifications do not apply when operating the device outside of its stated operating conditions.

Note 2: Human body model, $1.5 \text{ k}\Omega$ in series with 100pF.

Note 3: Power dissipation ≤ 0.75 W.

Note 4: Recommended minimum load capacitance of 0.01µF to limit high frequency noise.

Note 5: Typical thermal resistance values for the packages are:

Z Package: θ_{JC} = 60 °C/W, = θ_{JA} = 230 °C/W

M Package: $\theta_{JA} = 180 \text{ °C/W}$

micro SMD Package: $\theta_{JA} = 230.9^{\circ}C/W$

Maximum Average Power Dissipation (Z Package) 10 5.0 POWER DISSIPATION (W) OUTPUT CURRENT (mA) 0.125" LEAD LENGTH FROM PC BOARD WITH 72°C/W HEAT SINK 1.0 0.4" LEAD LENGTH FROM PC BOARD 0.5 FREE AIR 0.125" LEAD LENGTH FROM PC BOARD FREE AIR 0.1 0 15 30 45 60 75 AMBIENT TEMPERATURE (°C) 774414 **Dropout Voltage** 2.5 **NPUT-OUTPUT DIFFERENTIAL (V)** 2.0 = 70 mA IOUT RIPPLE REJECTION (dB) I_{OUT} = 40 mA 1.5 I_{OUT} = 1.0 mA 1.0 0.5 DROPOUT CONDITIONS Δ V_{OUT} = 2% of V_{OUT} 0 25 50 75 100 125 JUNCTION TEMPERATURE (°C) 774417 **Output Impedance** 10 v_{in} = 10v V_{OUT} = 5V 5.0 QUIESCENT CURRENT (mA) I_{OUT} = 40 mA T_A = 25°C C_{OUT} = 0 $C_{OUT} = 1 \mu F TANTALUM$ 1.0 0.5

Typical Performance Characteristics

Peak Output Current



Ripple Rejection











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 $V_{OUT} = 5V (R2/R4)$ for (R2 + R3) = (R4 + R5)A 0.5V output will correspond to (R2/R4) = 0.1 (R3/R4) = 0.9 Physical Dimensions inches (millimeters) unless otherwise noted



NOTES: UNLESS OTHERWIS

1. EPOXY COATING

2. 63Sn/37Pb EUTECTIC BUMP 3. RECOMMEND NON-SOLDER MASK DEFINED LANDING PAD.

4. PIN A1 IS ESTABLISHED BY LOWER LEFT CORNER WITH RESPECT TO TEXT ORIENTATION. REMAINING PINS ARE NUMBERED COUNTERCLOCK-WISE.

5. XXX IN DRAWING NUMBER REPRESENTS PACKAGE SIZE VARIATION WHERE X_1 IS PACKAGE WIDTH, X_2 IS PACKAGE LENGTH AND X_3 IS PACKAGE HEIGHT.

6. REFERENCE JEDEC REGISTRATION MO-211, VARIATION BC.

8-Bump micro SMD NS Package Number BPA08AAB X1 = 1.285mm X2 = 1.285mm X3 = 0.850mm



LM78LXX Series

ZO3A (Rev G)



Molded Offset TO-92 (Z) NS Package Number Z03A

Notes

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